# Dual Matched 40 V, 6.0 A, Low V<sub>CE(sat)</sub> PNP Transistor

These transistors are part of the ON Semiconductor  $e^2$ PowerEdge family of Low  $V_{CE(sat)}$  transistors. They are assembled to create a pair of devices highly matched in all parameters, including ultra low saturation voltage  $V_{CE(sat)}$ , high current gain and Base/Emitter turn on voltage.

Typical applications are current mirrors, differential amplifiers, DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e<sup>2</sup>PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

#### **Features**

- Current Gain Matching to 10%
- Base Emitter Voltage Matched to 2 mV
- This is a Pb-Free Device

# MAXIMUM RATINGS (TA) 25/17 BDT C COM

Rating	Symbol	Max	Unit	
Collector-Emitter Voltage	$V_{CEO}$	-40	Vdc	
Collector-Base Voltage	$V_{CBO}$	-40	Vdc	
Emitter-Base Voltage	$V_{EBO}$	-7.0	Vdc	
Collector Current - Continuous	I <sub>C</sub>	-3.0	Α	
Collector Current - Peak	I <sub>CM</sub>	-6.0	Α	
Electrostatic Discharge	ESD	HBM Class 3B MM Class C		

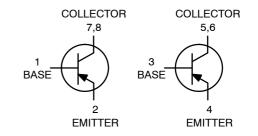
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



#### ON Semiconductor®

http://onsemi.com

# 40 VOLTS 6.0 AMPS PNP LOW $V_{CE(sat)}$ TRANSISTOR EQUIVALENT $R_{DS(on)}$ 80 m $\Omega$





#### **DEVICE MARKING**



P40300 = Specific Device Code A = Assembly Location

Y = Year WW = Work Week • = Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>	
NSS40300MDR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
SINGLE HEATED			
Total Device Dissipation (Note 1)  T <sub>A</sub> = 25°C	P <sub>D</sub>	576	mW
Derate above 25°C		4.6	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JA}$	217	°C/W
Total Device Dissipation (Note 2) T <sub>A</sub> = 25°C	P <sub>D</sub>	676	mW
Derate above 25°C		5.4	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	185	°C/W
DUAL HEATED (Note 3)			
Total Device Dissipation (Note 1) $T_{\Delta} = 25^{\circ}C$	P <sub>D</sub>	653	mW
Derate above 25°C		5.2	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ heta JA}$	191	°C/W
Total Device Dissipation (Note 2) $T_A = 25^{\circ}C$	P <sub>D</sub>	783	mW
Derate above 25°C		6.3	mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	160	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C

<sup>1.</sup> FR-4 @ 10 mm<sup>2</sup>, 1 oz. copper traces, still air. 2. FR-4 @ 100 mm<sup>2</sup>, 1 oz. copper traces, still air.

www.BDTIC.com/ON

<sup>3.</sup> Dual heated values assume total power is the sum of two equally powered devices.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				
Collector – Emitter Breakdown Voltage $(I_C = -10 \text{ mAdc}, I_B = 0)$	V <sub>(BR)</sub> CEO	-40	-	-	Vdc
Collector – Base Breakdown Voltage (I <sub>C</sub> = –0.1 mAdc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	-40	-	-	Vdc
Emitter – Base Breakdown Voltage $(I_E = -0.1 \text{ mAdc}, I_C = 0)$	V <sub>(BR)EBO</sub>	-7.0	-	-	Vdc
Collector Cutoff Current (V <sub>CB</sub> = -40 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	-	-	-0.1	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = -6.0 Vdc)	I <sub>EBO</sub>	-	-	-0.1	μAdc
ON CHARACTERISTICS					
DC Current Gain (Note 4) $ \begin{aligned} &(I_C = -10 \text{ mA, } V_{CE} = -2.0 \text{ V}) \\ &(I_C = -500 \text{ mA, } V_{CE} = -2.0 \text{ V}) \\ &(I_C = -1.0 \text{ A, } V_{CE} = -2.0 \text{ V}) \\ &(I_C = -1.0 \text{ A, } V_{CE} = -2.0 \text{ V}) \\ &(I_C = -2.0 \text{ A, } V_{CE} = -2.0 \text{ V}) \end{aligned} $ (Note 5)	h <sub>FE</sub>	250 220 180 150 0.9	380 340 300 230 0.99	- - - -	
Collector – Emitter Saturation Voltage (Note 4) $ \begin{aligned} &(I_C = -0.1 \text{ A, } I_B = -0.010 \text{ A}) \\ &(I_C = -1.0 \text{ A, } I_B = -0.100 \text{ A}) \\ &(I_C = -1.0 \text{ A, } I_B = -0.010 \text{ A}) \\ &(I_C = -2.0 \text{ A, } I_B = -0.200 \text{ A}) \end{aligned} $	V <sub>CE</sub> (sat)	- - - -	-0.013 -0.075 -0.130 -0.135	-0.017 -0.095 -0.170 -0.170	V
Base – Emitter Saturation Voltage (Note 4) (I <sub>C</sub> = -1.0 A, I <sub>B</sub> = -0.01 A)	V <sub>BE(sat)</sub>	-	-0.780	-0.900	V
Base - Emitter Tu n on Vy tag > (Vyte 4) (I <sub>C</sub> = -0.1 A, V <sub>CE</sub> + -20 V) (I <sub>C</sub> = -0.1 A, V <sub>CE</sub> = -2.0 V) (Note 6)	V <sub>BE(0n)</sub> V <sub>BE(1) -</sub> V <sub>BE(2)</sub>		-0.660 0.3	-1.750 2.0	V mV
Cutoff Frequency ( $I_C = -100 \text{ mA}$ , $V_{CE} = -5.0 \text{ V}$ , $f = 100 \text{ MHz}$ )	f <sub>T</sub>	100	-	-	MHz
Input Capacitance (V <sub>EB</sub> = -0.5 V, f = 1.0 MHz)	Cibo	-	250	300	pF
Output Capacitance (V <sub>CB</sub> = -3.0 V, f = 1.0 MHz)	Cobo	-	50	65	pF
SWITCHING CHARACTERISTICS	•		•		•
Delay ( $V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$ )	t <sub>d</sub>	-	-	60	ns
Rise ( $V_{CC} = -30 \text{ V}, I_C = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$ )	t <sub>r</sub>	-	-	120	ns
Storage ( $V_{CC} = -30 \text{ V}, I_{C} = -750 \text{ mA}, I_{B1} = -15 \text{ mA}$ )	t <sub>s</sub>	-	-	400	ns
Fall ( $V_{CC} = -30 \text{ V}$ , $I_C = -750 \text{ mA}$ , $I_{B1} = -15 \text{ mA}$ )	t <sub>f</sub>	_	_	130	ns

Pulsed Condition: Pulse Width = 300 μsec, Duty Cycle ≤ 2%.
 h<sub>FE(1)</sub>/h<sub>FE(2)</sub> is the ratio of one transistor compared to the other transistor within the same package. The smaller h<sub>FE</sub> is used as numerator.
 V<sub>BE(1)</sub> - V<sub>BE(2)</sub> is the absolute difference of one transistor compared to the other transistor within the same package.

#### TYPICAL CHARACTERISTICS

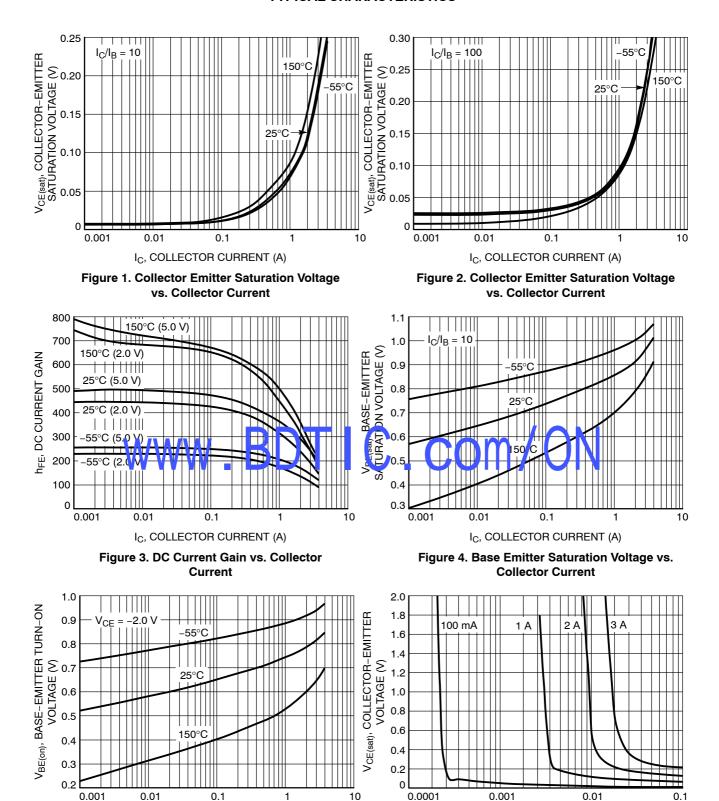


Figure 5. Base Emitter Turn-On Voltage vs.
Collector Current

IC, COLLECTOR CURRENT (A)

I<sub>b</sub>, BASE CURRENT (A)

Figure 6. Saturation Region

#### **TYPICAL CHARACTERISTICS**

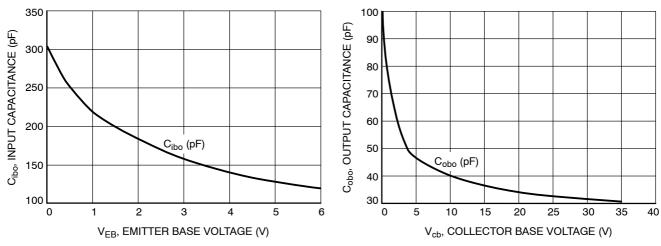


Figure 7. Input Capacitance

Figure 8. Output Capacitance

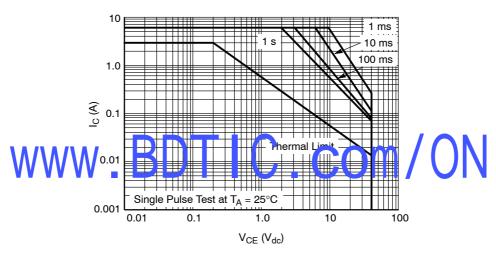
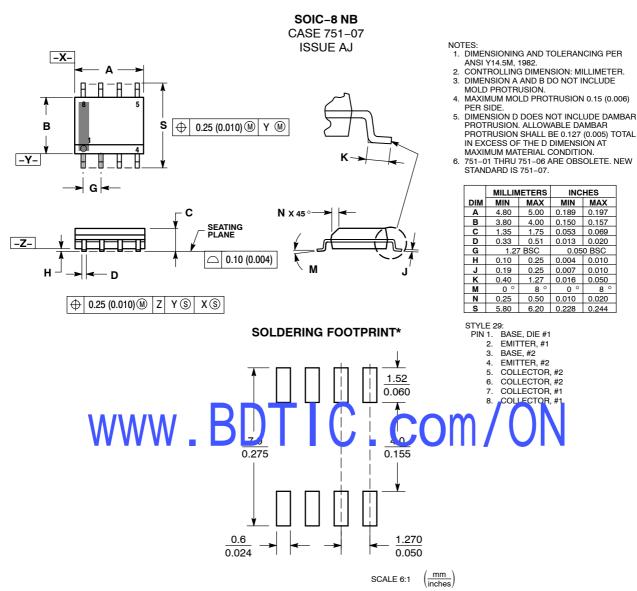


Figure 9. Safe Operating Area

#### PACKAGE DIMENSIONS



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

## LITERATURE FULFILLMENT: Literature Distribution Center for ON Semiconductor

P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5773-3850 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative